

FEATURES:

- 5Ω A/B bi-directional bus switch
- Isolation under power-off conditions
- Over-voltage tolerant
- Latch-up performance exceeds 100mA
- V_{CC} = 2.3V - 3.6V, Normal Range
- ESD > 2000V per MIL-STD-883, Method 3015;
> 200V using machine model (C = 200pF, R = 0)
- Available in QSOP and TSSOP packages

APPLICATIONS:

- 3.3V High Speed Bus Switching and Bus Isolation

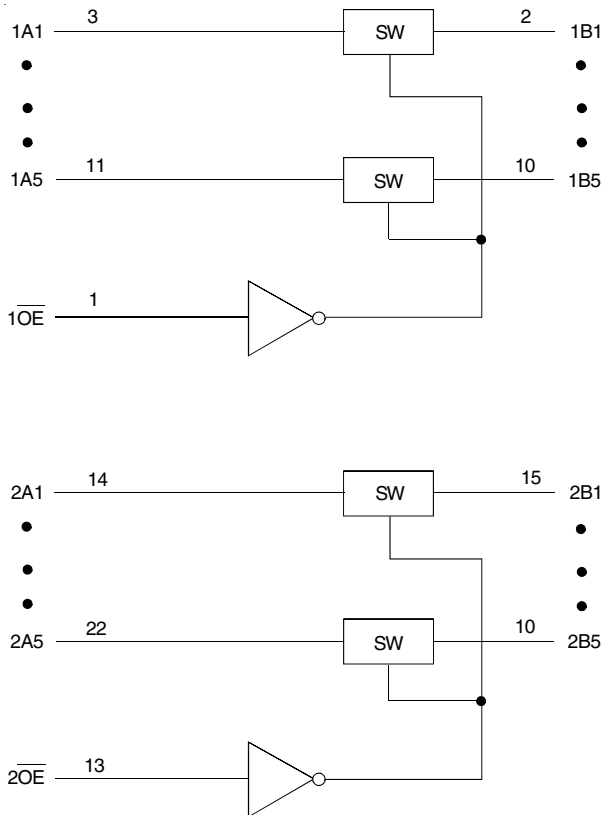
DESCRIPTION:

The CBTLV3384 is a ten bit high-speed bus switch with low on-state resistance of the switch allowing connections to be made with minimal propagation delay.

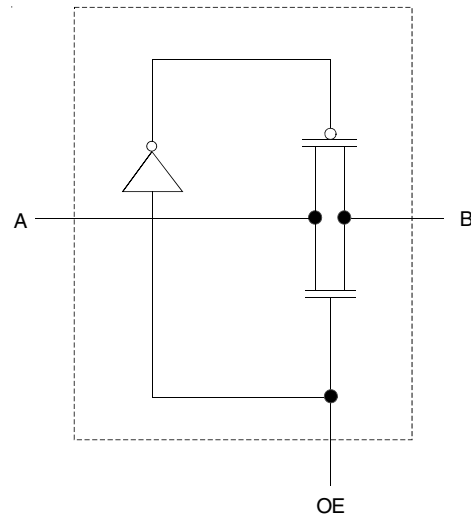
The device is organized as dual 5-bit bus switches with separate output-enable (\overline{OE}) inputs, to allow use as two 5-bit bus switches or one 10-bit bus switch. When \overline{OE} is low, the associated 5-bit bus switch is on and A port is connected to B port. When \overline{OE} is high, the switch is open, and a high-impedance state exists between the two ports.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

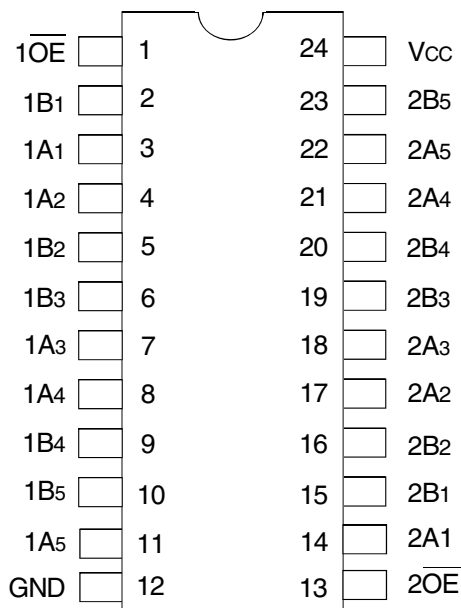
FUNCTIONAL BLOCK DIAGRAM



SIMPLIFIED SCHEMATIC, EACH SWITCH



PIN CONFIGURATION



TOP VIEW

Package Type	Package Code	Order Code
TSSOP	PGG24	PGG
QSOP	PCG24	QG

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
V _{CC}	Supply Voltage Range	-0.5 to +4.6	V
V _I	Input Voltage Range	-0.5 to +4.6	V
	Continuous Channel Current	128	mA
I _{IK}	Input Clamp Current, V _{I/O} < 0	-50	mA
T _{STG}	Storage Temperature	-65 to +150	°C

NOTE:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

FUNCTION TABLE⁽¹⁾

Input		Inputs/Outputs	
1OE	2OE	1B1 - 1B5	2B1 - 2B5
L	L	1A1 - 1A5	2A1 - 2A5
L	H	1A1 - 1A5	Z
H	L	Z	2A1 - 2A5
H	H	Z	Z

NOTE:

1. H = HIGH Voltage Level
L = LOW Voltage Level
Z = High Impedance

OPERATING CHARACTERISTICS, T_A = 25°C⁽¹⁾

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _{CC}	Supply Voltage		2.3	3.6	V
V _{IH}	High-Level Control Input Voltage	V _{CC} = 2.3V to 2.7V	1.7	—	V
		V _{CC} = 2.7V to 3.6V	2	—	
V _{IL}	Low-Level Control Input Voltage	V _{CC} = 2.3V to 2.7V	—	0.7	V
		V _{CC} = 2.7V to 3.6V	—	0.8	
T _A	Operating Free-Air Temperature		-40	85	°C

NOTE:

1. All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

 Operating Conditions: $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
V_{IK}	Control Inputs, Data I/O	$V_{CC} = 3V$, $I_I = -18\text{mA}$	—	—	-1.2	V	
I_I	Control Inputs, Data I/O	$V_{CC} = 3.6V$, $V_I = V_{CC}$ or GND	—	—	± 1	μA	
I_{OZ}	Data I/O	$V_{CC} = 3.6V$, $V_O = 0$ or $3.6V$, switch disabled	—	—	5	μA	
I_{OFF}		$V_{CC} = 0$, V_I or $V_O = 0$ to $3.6V$	—	—	50	μA	
I_{CC}		$V_{CC} = 3.6V$, $I_O = 0$, $V_I = V_{CC}$ or GND	—	—	10	μA	
$\Delta I_{CC}^{(1)}$	Control Inputs	$V_{CC} = 3.6V$, one input at $3V$, other inputs at V_{CC} or GND	—	—	300	μA	
C_I	Control Inputs	$V_I = 3V$ or 0	—	4	—	pF	
$C_{IO(OFF)}$		$V_O = 3V$ or 0 , $\overline{OE} = V_{CC}$	—	7	—	pF	
$R_{ON}^{(2)}$	Max. at $V_{CC} = 2.3V$ Typ. at $V_{CC} = 2.5V$	$V_I = 0$	$I_O = 64\text{mA}$	—	5	8	Ω
			$I_O = 24\text{mA}$	—	5	8	
	$V_I = 1.7V$	$I_O = 15\text{mA}$	—	27	40		
	$V_{CC} = 3V$	$V_I = 0$	$I_O = 64\text{mA}$	—	5	7	
			$I_O = 24\text{mA}$	—	5	7	
		$V_I = 2.4V$	$I_O = 15\text{mA}$	—	10	15	

NOTES:

- The increase in supply current is attributable to each current that is at the specified voltage level rather than V_{CC} or GND.
- This is measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

SWITCHING CHARACTERISTICS

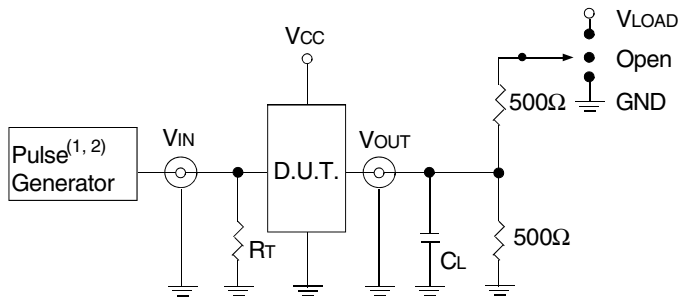
Symbol	Parameter	$V_{CC} = 2.5V \pm 0.2V$		$V_{CC} = 3.3V \pm 0.3V$		Unit
		Min.	Max.	Min.	Max.	
$t_{PD}^{(1)}$	Propagation Delay A to B or B to A	—	0.15	—	0.25	ns
t_{EN}	Output Enable Time \overline{OE} to A or B	1	5	1	4.3	ns
t_{DIS}	Output Disable Time \overline{OE} to A or B	1	5.5	1	5.5	ns

- NOTE:**
- The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance driven by an ideal voltage source (zero output impedance).

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	V _{CC} ⁽¹⁾ = 3.3V±0.3V	V _{CC} ⁽²⁾ = 2.5V±0.2V	Unit
V _{LOAD}	6	2 x V _{CC}	V
V _{IH}	3	V _{CC}	V
V _T	1.5	V _{CC} / 2	V
V _{LZ}	300	150	mV
V _{HZ}	300	150	mV
C _L	50	30	pF



Test Circuits for All Outputs

DEFINITIONS:

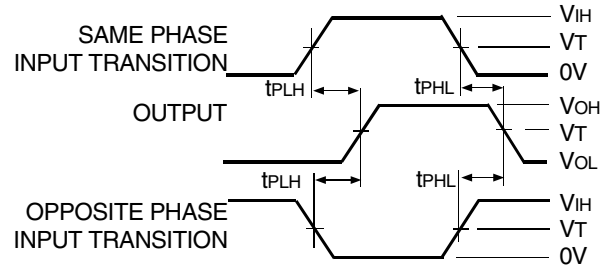
C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

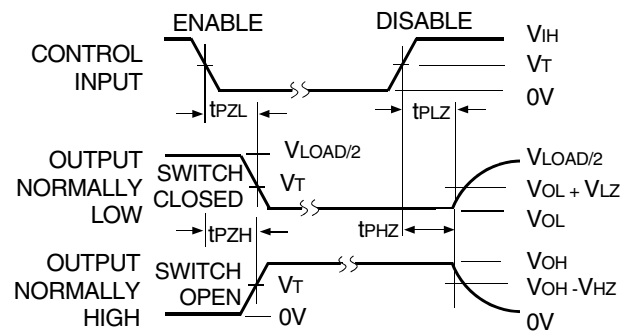
1. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_r ≤ 2.5ns; t_r ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_r ≤ 2ns; t_r ≤ 2.5ns.

SWITCH POSITION

Test	Switch
t _{PLZ} /t _{PZL}	V _{LOAD}
t _{PHZ} /t _{PZH}	GND
t _{PD}	Open

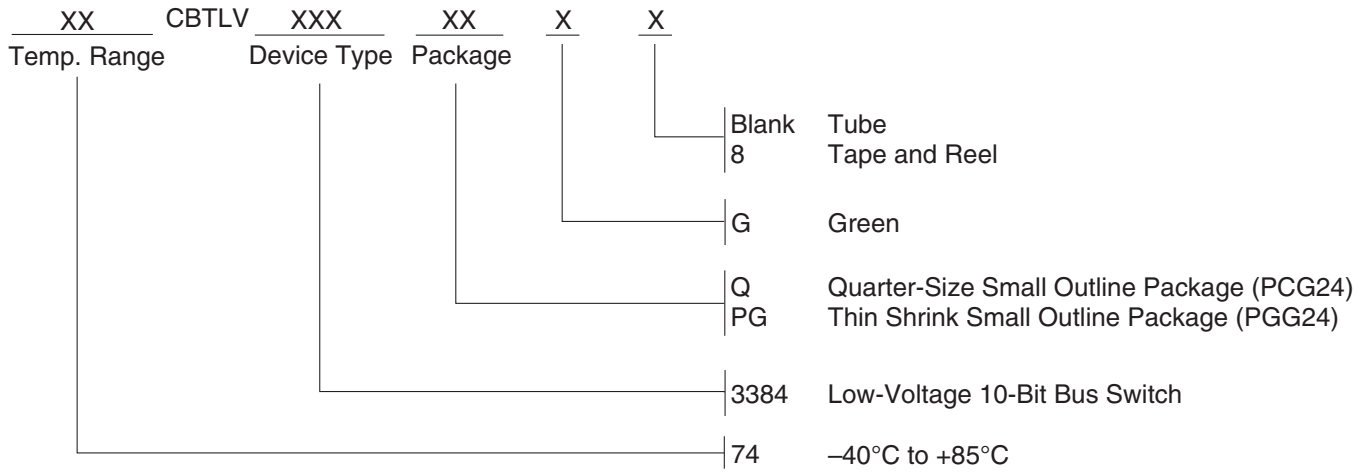


Propagation Delay



Enable and Disable Times

ORDERING INFORMATION



Orderable Part Information

Speed (ns)	Orderable Part ID	Pkg. Code	Pkg. Type	Temp. Grade
	74CBTLV3384PGG	PGG24	TSSOP	I
	74CBTLV3384PGG8	PGG24	TSSOP	I
	74CBTLV3384QG	PCG24	QSOP	I
	74CBTLV3384QG8	PCG24	QSOP	I

Datasheet Document History

- 12/18/2014 Pg. 5 Updated the ordering information by removing non RoHS part and by adding Tape and Reel information.
- 05/10/2019 Pg. 2,5 Added table under pin configuration diagram with detailed package information and orderable part information table.
Updated the ordering information diagram in clearer detail.

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